

BIPOLAR ANALOG INTEGRATED CIRCUIT

μPC661

VIDEO SIGNAL PROCESSING 6-BIT A/D CONVERTER WITH BUILT-IN ANALOG MULTIPLEXER AND CLAMPER

The μ PC661 is a 6-bit A/D converter for video systems. The high-speed/high-precision bipolar processing technology embodied in this IC realizes 20 Msps and \pm 0.5 LSB (MAX.). The low power consumption design provide wide applicability of this IC to digital systems in various fields, such as digital TV systems, PIP (Picture-in-picture) system, or high speed facsimile system.

This IC has a built-in analog multiplexer for four inputs together with a clamper for each input for selective A/D conversion of video signal. In addition, a reference voltage generator is also built in for simpler circuit configurations.

CHARACTERISTICS

• Resolution: 6 bits

Conversion Rate: 20 Msps

• Non-Linearity Error: ±0.5 LSB

• +5 V Single Power Supply

Input voltage Range: 1.0 V_{p−p}

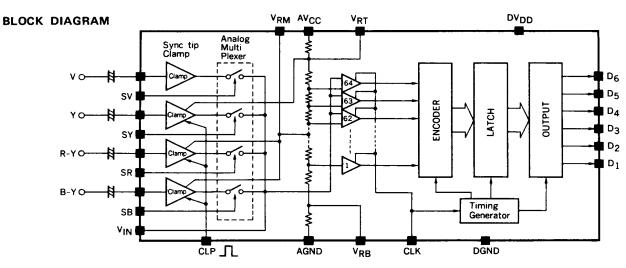
Built-in Clamp circuit.

Built-in reference voltage generator: V_{RB} = 2.5 V, V_{RM} = 3.0 V, V_{RT} = 3.5 V

Built-in Analog Multiplexer. (For 4 inputs.)

Power Consumption: 200 mW (TYP.)

• Package: 24-pin SHD, 24-pin SOP (375 mil)



ORDER INFORMATION

Order name	Package	
μPC661CA	24-pin SHD (300 mil)	
μPC661G	24-pin SOP (375 mil)	

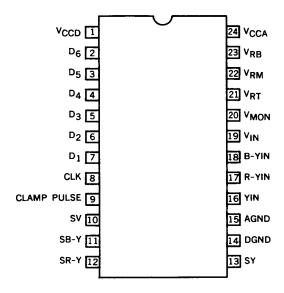
The specifications of this product are subject to change without prior notice.

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PIN CONNECTION DIAGRAM (Top View)



Pin number	Symbol	Pin name	Pin number	Symbol	Pin name
1	VCCD	Digital power supply	13	SY	Luminance signal selector (Y)
2	D ₆	Digital output (LSB)	14	DGND	GND
3	D ₅	Digital output	15	AGND	GND
4	D4	Digital output	16	YIN	Luminance signal input (Y)
5	D ₃	Digital output	17	R-YIN	Color difference signal input (R-Y)
6	D ₂	Digital output	18	B-YIN	Color difference signal input (B-Y)
7	D ₁	Digital output (MSB)	19	VIN	Video signal input
8	CLK	Clock input	20	VMON	Analog Monitor
9	CLAMP PULSE	Clamp pulse input	21	VRT	Reference voltage (high-level voltage)
10	sv	Video signal selector	22	VRM	Reference voltage (intermediate-level voltage)
11	SB-Y	Color difference signal selector (B-Y)	23	VRB	Reference voltage (lower voltage)
12	SR-Y	Color difference signal selector (R-Y)	24	VCCA	Analog power supply

ABSOLUTE MAXIMUM RATINGS ($T_a = 25$ °C)

Supply Voltage AV_{CC} , DV_{CC} -0.3 to +5.7 V Input Voltage on Each Pin V_1 -0.3 to V_{CC} +0.3 V Operating Temperature Range T_{opt} -20 to +75 °C Storage Temperature Range T_{stg} -40 to +150 °C

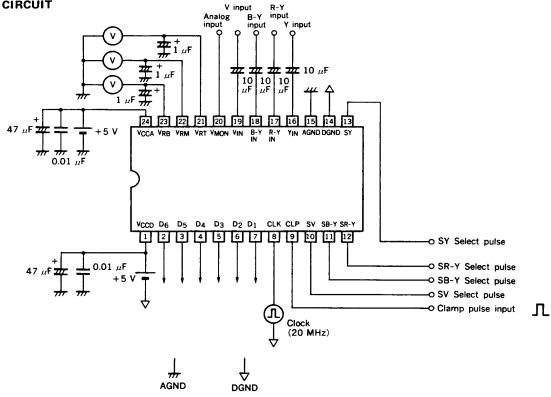
RECOMMENDED OPERATING CONDITIONS ($T_a = -20 \text{ to } +75 \,^{\circ}\text{C}$)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITION
Supply voltage	AVCC, DVCC	4.5	5.0	5.5	V	AGND = DGND = 0 V
Analog input voltage	VINA	V _{RB} -0.4		V _{RT} +0.4	٧	
Sampling clock	f _{samp}	1		20	MHz	
Sampling clock low-level pulse width	tpwL	20			ns	
Sampling clock high-level pulse width	tpWH	20			ns	
Select pulse high-level width	t _{se}	150			ns	
Clamp pulse high-level pulse width	tPWCH	1			μs	
Clamp pulse low-level width	tPWCL			100	μs	Clamp capacitance C _{CL} = 10 μF
Clamp capacitance	C _{CL}		10		μF	
Digital input high-level voltage	VINDH	2.7			V	
Digital input low-level voltage	VINDL			0.4	٧	

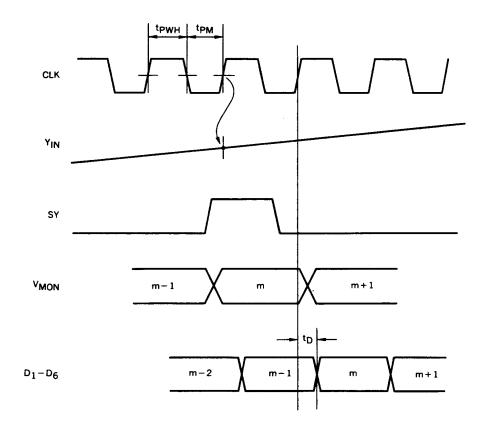
ELECTRICAL RATINGS ($T_a = -20 \text{ to } +75 \,^{\circ}\text{C}$, $AV_{CC} = DV_{CC} = 5.0 \pm 0.5 \,\text{V}$)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Power consumption	Icc	32	46	60	mA	AV _{CC} = DV _{CC} = 5.0 V, T _a = 25 °C
Nonlinearity error	NL			±0.25	LSB	V _{CC} = 5.0 V, T _a = 0 to 60 °C, V _{INA} = 1 V _{p-p} f _{samp} = 20 MHz
Differential linearity error	DNL			±0,25	LSB	V _{CC} = 5.0 V, T _a = 0 to 60 °C, V _{INA} = 1 V _{p-p} f _{samp} = 20 MHz
Data output delay time	tD		12		ns	Delay time from the rise of the clock signal, D ₁ to D ₆
Digital low-level output voltage	VOL			0.4	V	IOL = 1.6 mA
Digital high-level output voltage	Voн	2.7			V	1 _{OH} = -400 μA
Digital low-level input current	INDL			-300	μА	I _{INDL} = 0.8 V
Digital high-level input current	INDH			20	μА	VINDH = 2.0 V
Reference voltage (low-voltage side)	VRB	2.2	2.5	2.8	V	VCCA = 5.0 V
Reference voltage (intermediate-voltage side)	VRM	2.7	3.0	3.3	V	V _{CCA} = 5.0 V
Reference voltage (high-voltage side)	VRT	3.2	3.5	3.8	V	V _{CCA} = 5.0 V
Analog input capacitance	CIN			7	рF	VIN = VRB
Clock input capacitance	CCLK		2	5	pF	

MEASUREMENT CIRCUIT



TIMING CHART



PIN NUMBER	EQUIVALENT CIRCUIT DIAGRAM	DESCRIPTION OF FUNCTIONS
1	DV _{CC}	Digital system power supply
2, 3, 4, 5, 6, 7	DV _{CC}	2: Digital data output (MSB) 3: Digital data output (5th) 4: Digital data output (4th) 5: Digital data output (3rd) 6: Digital data output (2nd) 7: Digital data output (1st) Digital data output terminals. The data is output one digital output delay period (tD) after the rise of the clock. (Refer to the Timing Chart). Output at the TTL level.
8	B DVCC	Clock signal input terminal. Analog input is fetched and digital data is output at the rise of the signal input to this terminal.
9	9 AGND AGND	Clamp pulse input terminal for color difference signal (R-Y, B-Y) and luminance signal (Y). The signal is clamped when this terminal is high.
10, 11, 12, 13	AVCC 10 AGND	10: Analog multiplexer switching signal input (SV). This terminal selects the signal from the VIN terminal (Pin 19) while this terminal is high. 11: Analog multiplexer switching signal input (SB-Y). This terminal selects the signal from the B-YIN terminal (Pin 18) while this terminal is high. 12: Analog multiplexer switching signal input (SR-Y). This terminal selects the signal from the R-YIN terminal (Pin 17) while this terminal is high. 13: Analog multiplexer switching signal input (SY) This terminal selects the signal from the YIN terminal (Pin 16) while this terminal is high.

PIN NUMBER	EQUIVALENT CIRCUIT DIAGRAM	DESCRIPTION OF FUNCTIONS
14	↓ DGND	Digital system grounding terminal.
15	AGND	Analog system grounding terminal.
16, 17, 18	AVCC AVCC AGND AGND	 16: Luminance signal (Y) input terminal and clamper. Input level: 1 V_{P-P}. Clamping level: V_{RT}. 17: R-Y input terminal and clamper. Input level: 1 V_{P-P}. Clamping level: V_{RM}. 18: B-Y input terminal and clamper. Input level: 1 V_{P-P}. Clamping level: V_{RM}.
19	AV _{CC} 19	Composite video signal input terminal and clamper. Input level: 1 V _{p-p} . The clamp is a sink chip (minimum value) clamp.
	AVCC 0 1 1 AGND 1 1 63	Analog multiplexer output monitor terminal. This terminal monitors the input signal selected by pins 10 to 13. This terminal is normally open.

PIN NUMBER	EQUIVALENT CIRCUIT DIAGRAM	DESCRIPTION OF FUNCTIONS
21	Å AV _{CC}	21: Reference voltage output terminal (high-voltage side). VRT.
22	21	22: Reference voltage output terminal (Intermediate-voltage side), V _{RM} .
23	22	23: Reference voltage output terminal (low-voltage side). VRB.
24	AVCC	24: Analog system power supply.



SUPPLEMENT

Clamp Operation

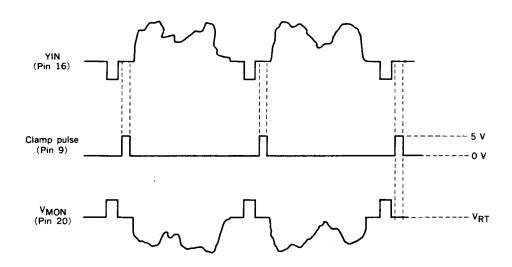
This IC has a built-in clamper that clamps using the coupling capacitance of the respective analog signal input terminals 16 to 19.

1) Clamping of the video signal input, V_{IN} (Pin 19)

The clamping here is based on the minimum value clamping system, which is mainly used for clamping the video sink chip. The voltage during clamping is generated by the internal regulator. Note that this clamper operates independently from the clamp pulse on the pin 9.

2) Clamping of the luminance signal input, YIN (Pin 16)

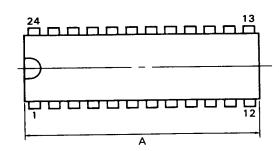
Clamping here is executed when the clamp pulse on pin 9 is high. When the clamp pulse is high, the signal voltage supplied from the pin 16 is clamped to V_{RT} (reference high voltage) at the V_{INA} terminal (Pin 20). The timing and the level of the clamping by the pedestal are as follows:

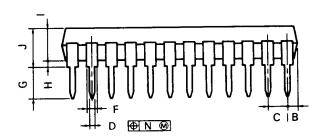


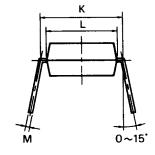
3) Clamping of the color difference signals: R-YIN (Pin 17) and B-YIN (Pin 18)

This clamping is executed while the clamp pulse at pin 9 is high. When the clamp pulse is high, the signal voltage supplied from the pin 17 or 18 is clamped to V_{RM} (intermediate reference voltage) at the V_{IN} (Pin 20) terminal.

24-PIN PLASTIC SHRINK DIP (300 mil) (Unit : mm)







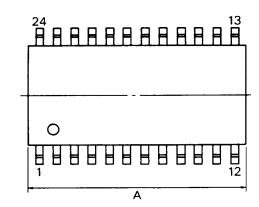
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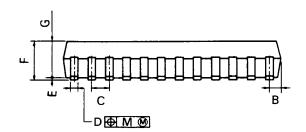
NOTES

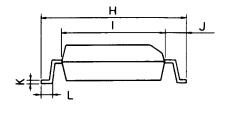
- Each lead centerline is located within 0.17 mm (0.007 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS	INCHES
Α	23.12 MAX.	0.911 MAX.
В	1.78 MAX.	0.070 MAX.
С	1.778 (T.P.)	0.070 (T.P.)
D	0.50 ± 0.10	0.020 -0.005
F	0.85 MIN.	0.033 MIN.
G	3.2 * 0.3	0.126 ± 0.012
Н	0.51 MIN.	0.020 MIN.
1	4.31 MAX.	0.170 MAX.
J	5.08 MAX.	0.200 MAX.
К	7.62 (T.P.)	0.300 (T.P.)
L	6.5	0.256
М	0.25 -0.10	0.010 -0.003
N	0.17	0.007

24-PIN PLASTIC SOP (375 mil) (Unit: mm)







P24GM-50-375B

NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
Α	15.54 MAX.	0.612 MAX.
В	0.78 MAX.	0.031 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	0.40 - 8.66	0.016 0.004
E	0.1 10.1	0.004 *0.004
F	2.9 MAX.	0.115 MAX.
G	2.50	0.098
н	10.3 ^{· o.3}	0.406 8 813
ı	7.2	0.283
J	1.6	0.063
К	0.15-8.65	0.006 - 0.004
L	0.8 ±0.2	0.031-0.008
М	0.12	0.005